Product data sheet

1. General description

Dual hyperfast power diode in a TO220F plastic package.

2. Features and benefits

- Fast switching
- · Isolated plastic package
- · Low leakage current
- · Low reverse recovery current
- · Low thermal resistance
- · High thermal cycling performance

3. Applications

- · Active PFC in air conditioner
- Continuous Current Mode (CCM) Power Factor Correction (PFC)
- · Half-bridge/full-bridge switched-mode power supplies

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values		Unit		
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		400			V	
I _{O(AV)}	average output current	$δ = 0.5$; $T_h \le 87$ °C; square-wave pulse; both diodes conducting; Fig. 1; Fig. 2; Fig. 3	10			А	
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _h ≤ 112 °C; square-wave pulse; per diode	10			Α	
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode; Fig. 4	70		Α		
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	77		Α		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; per diode; <u>Fig. 6</u>		-	1.3	1.5	V
		I _F = 5 A; T _j = 150 °C; per diode; <u>Fig. 6</u>	- 0.88 1.3		V		
Dynamic	characteristics				,		
t _{rr}	reverse recovery time	$I_F = 5 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 100 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; per diode; Fig. 7$		-	38	40	ns

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode	mb	
2	K	cathode		A1
3	A2	anode		A1 A2
mb	n.c.	mounting base; isolated		K sym125

6. Ordering information

Table 3. Ordering information

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BYC405X-400P	TO220F	BYC405X-400PQ	Tube	50	SOT186A	14-Nov-2013

7. Marking

Table 4. Marking codes

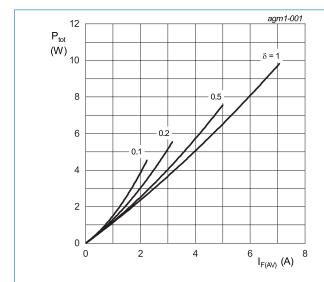
Type number	Marking codes
BYC405X-400P	BYC405X-400P

8. Limiting values

Table 5. Limiting values

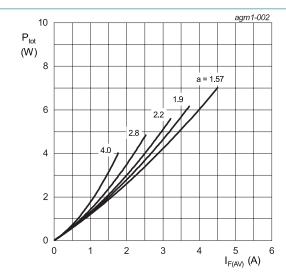
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		400	V
V_{RWM}	crest working reverse voltage		400	V
V_R	reverse voltage	DC	400	V
I _{O(AV)}	average output current	δ = 0.5 ; T _h ≤ 87 °C; square-wave pulse; both diodes conducting; Fig. 1; Fig. 2; Fig. 3	10	А
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _h ≤ 112 °C; square-wave pulse; per diode	10	А
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode; Fig. 4	70	А
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	77	А
T _{stg}	storage temperature		-55 to 150	°C
T _j	junction temperature		150	°C



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ $V_o = 1.097 \text{ V}; \text{ R}_s = 0.0415 \Omega$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode



a = form factor = $I_{F(RMS)}/I_{F(AV)}$ V_o = 1.097 V; R_s = 0.0415 Ω

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values; per diode

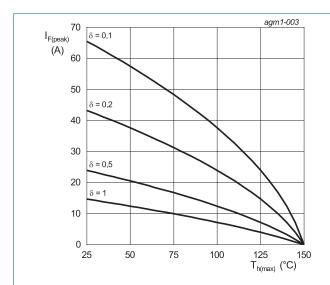


Fig. 3. Current derating as a function of heatsink temperature; per diode

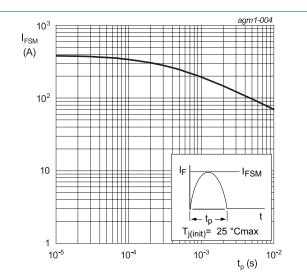
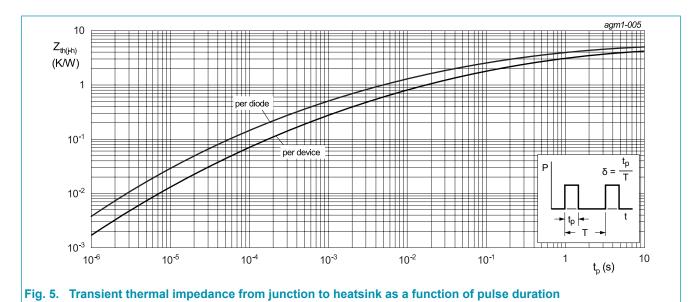


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values; per diode

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to	with heatsink compound; per diode; Fig. 5	-	-	5	K/W
	heatsink	with heatsink compound; both diodes conducting; Fig. 5	-	-	4.2	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



10. Isolation characteristics

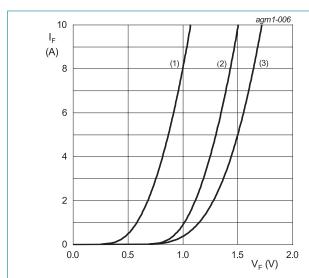
Table 7. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	50 Hz ≤ f ≤ 60 Hz; RH ≤ 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from cathode to external heatsink	-	10	-	pF

11. Characteristics

Table 8. Characteristics

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
V_{F}	forward voltage	$I_F = 5 \text{ A}$; $T_j = 25 \text{ °C}$; per diode; Fig. 6		-	1.3	1.5	V
		I _F = 5 A; T _j = 150 °C; per diode; <u>Fig. 6</u>		-	0.88	1.3	V
I _R	reverse current	V _R = 400 V; T _j = 25 °C		-	-	10	μA
		V _R = 400 V; T _j = 150 °C		-	-	200	μA
Dynamic	characteristics						
t _{rr}	reverse recovery time	$I_F = 5 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 100 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	38	40	ns
I _{RM}	peak reverse recovery current	$I_F = 5 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	1.2	-	А
Q _r	recovered charge	$I_F = 5 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 100 \text{ A}/\mu\text{s};$ $T_j = 25 ^{\circ}\text{C}; Fig. 7$		-	22	-	nC



 $V_o = 1.097 \text{ V}; R_s = 0.0415 \Omega$

(1) T_i = 150 °C; typical values

(2) T_i = 150 °C; maximum values

(3) T_i = 25 °C; maximum values

Fig. 6. Forward current as a function of forward voltage; per diode

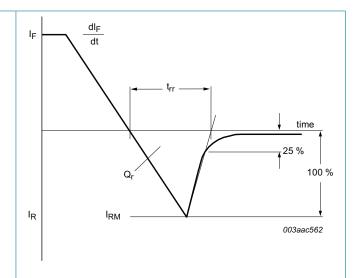
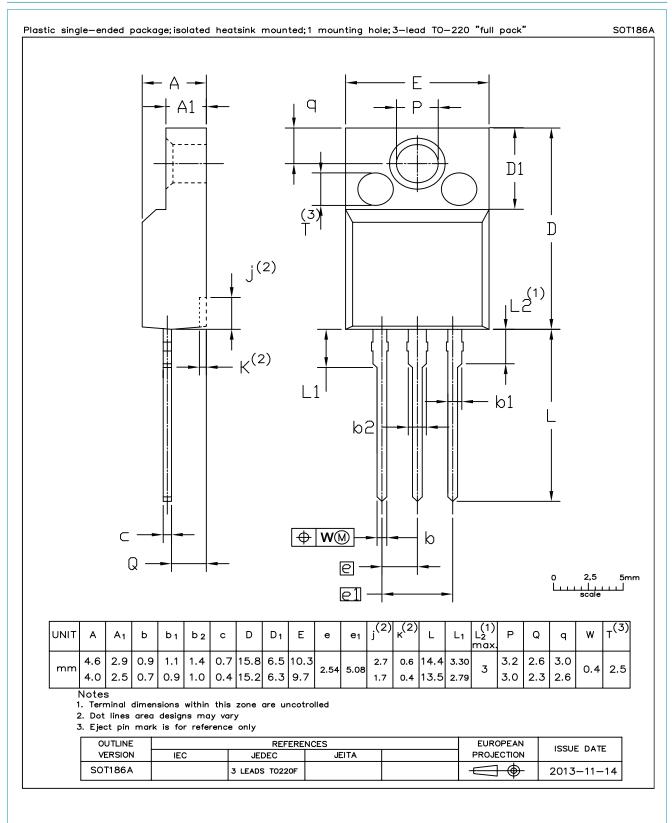


Fig. 7. Reverse recovery definitions; ramp recovery

12. Package outline



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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